SiHH21N65EF

Vishay Siliconix

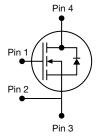


E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.157				
Q _g max. (nC)	102					
Q _{gs} (nC)	15					
Q _{gd} (nC)	28					
Configuration	Single					

PowerPAK[®] 8 x 8





N-Channel MOSFET

FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 8 x 8			
Lead (Pb)-free and Halogen-free	SiHH21N65EF-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	650	V			
Gate-Source Voltage	V _{GS}	± 30	- V			
Continuous Drain Current (T _J = 150 °C)	$T_{\rm C} = 25 ^{\circ}{\rm C}$	ID	19.8			
	$V_{GS} \text{ at 10 V} \qquad T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} $		12.5	A		
Pulsed Drain Current ^a	I _{DM}	53				
Linear Derating Factor		1.47	W/°C			
Single Pulse Avalanche Energy ^b	E _{AS}	353	mJ			
Maximum Power Dissipation	PD	156	W			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C			
Drain-Source Voltage Slope	T _J = 125 °C	-l) / / -l+	70	V/ns		
Reverse Diode dV/dt ^c	dV/dt	10	v/ns			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.
- c. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	39 51			0000			
Maximum Junction-to-Case (Drain)	R _{thJC}	0.51 0.68			°C/W			
SPECIFICATIONS ($T_J = 25 \degree C$, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C,	I _D = 10 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2.0	-	4.0	V
Osta Osumas Laskana		\ \	$I_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	\ \	$I_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zaura Oasta Malta era Duaia Orumant		V _{DS} =	520 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 V	, V _{GS} = 0 V	, T _J = 125 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	ار	₀ = 11 A	-	0.157	0.180	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 30 V, I _D =	= 11 A	-	7.8	-	S
Dynamic		•			•	•	•	
Input Capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		-	2396	-	-
Output Capacitance	C _{oss}	```			-	99	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	2	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	74	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	316	-		
Total Gate Charge	Qg				-	68	102	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	15	-	nC
Gate-Drain Charge	Q _{gd}				-	28	-	1
Turn-On Delay Time	t _{d(on)}				-	24	48	
Rise Time	t _r	V _{DD} =	520 V, I _D =	= 11 A,	-	43	86	- ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	10 V, R _g =	= 9.1 Ω	-	72	108	
Fall Time	t _f				-	46	92	
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.27	0.55	1.10	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	ا _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19.8	A	
Pulsed Diode Forward Current	I _{SM}			-	-	53		
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A	, V _{GS} = 0 V	-	0.95	1.3	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, $I_F = I_S = 11 \text{ A}$, dl/dt = 100 A/µs, $V_R = 25 \text{ V}$		-	145	290	ns	
Reverse Recovery Charge	Q _{rr}			-	0.9	1.8	μC	
	I _{RRM}			-	11.6	-	А	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

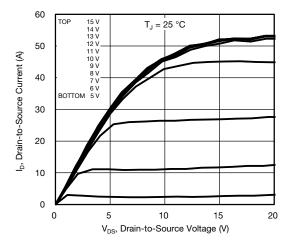


Fig. 1 - Typical Output Characteristics

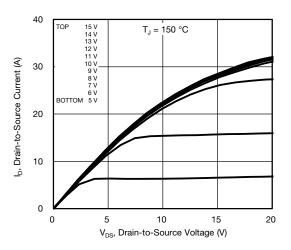


Fig. 2 - Typical Output Characteristics

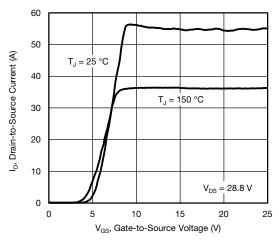


Fig. 3 - Typical Transfer Characteristics

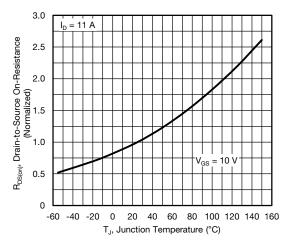


Fig. 4 - Normalized On-Resistance vs. Temperature

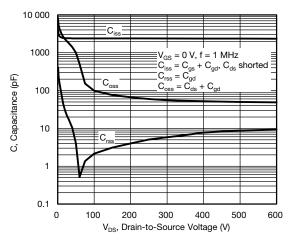


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

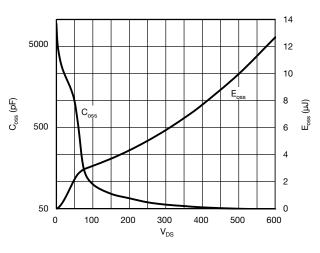


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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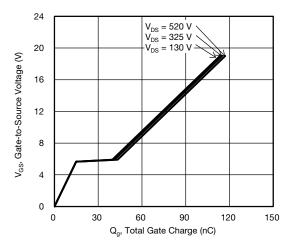


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

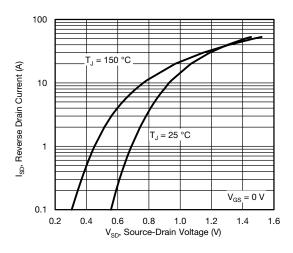


Fig. 8 - Typical Source-Drain Diode Forward Voltage

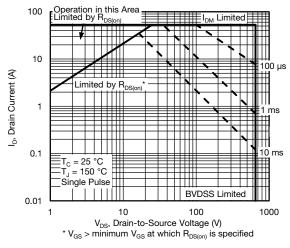


Fig. 9 - Maximum Safe Operating Area

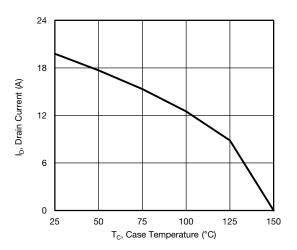


Fig. 10 - Maximum Drain Current vs. Case Temperature

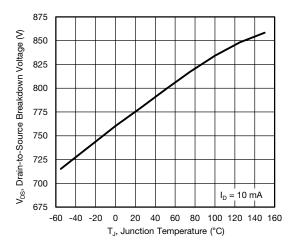


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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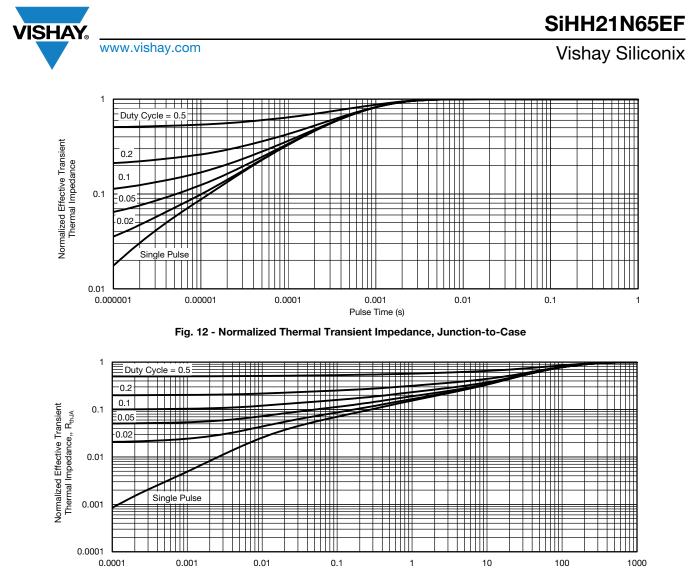


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

Pulse Time (s)

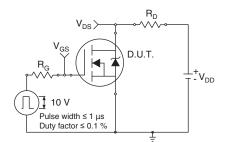


Fig. 14 - Switching Time Test Circuit

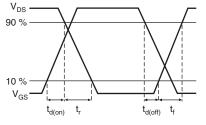


Fig. 15 - Switching Time Waveforms

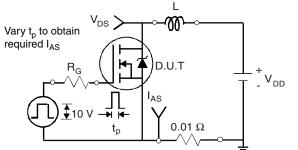
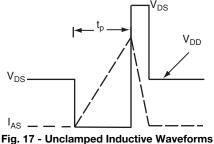
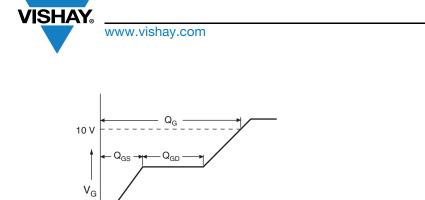


Fig. 16 - Unclamped Inductive Test Circuit



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Charge -----

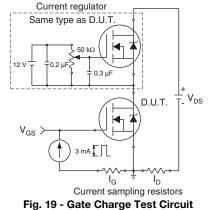


Fig. 18 - Basic Gate Charge Waveform



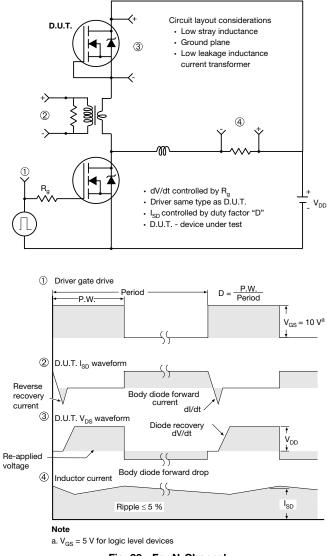


Fig. 20 - For N-Channel

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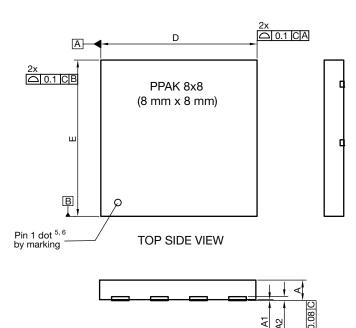
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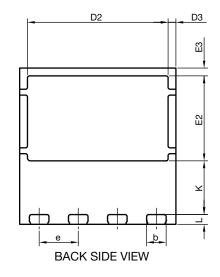
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PowerPAK[®] 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES			
Dilvi.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A ⁸	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2	020 ref.		0.008 ref.				
b ⁴	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC			0.016 BSC		
e		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3	0.40 BSC		0.016 BSC				
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ³		8	8				

D

Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5 M - 1994.

3. N is the number of terminals.

4. Package warpage max. 0.08 mm.

5. The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

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Revision: 18-May-15

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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